

APPENDIX-PHOTOGRAPHS OF EUT CONSTRUCTIONAL DETAILS**Model: Note 10****Photo 1****Photo 2**

Photo 3

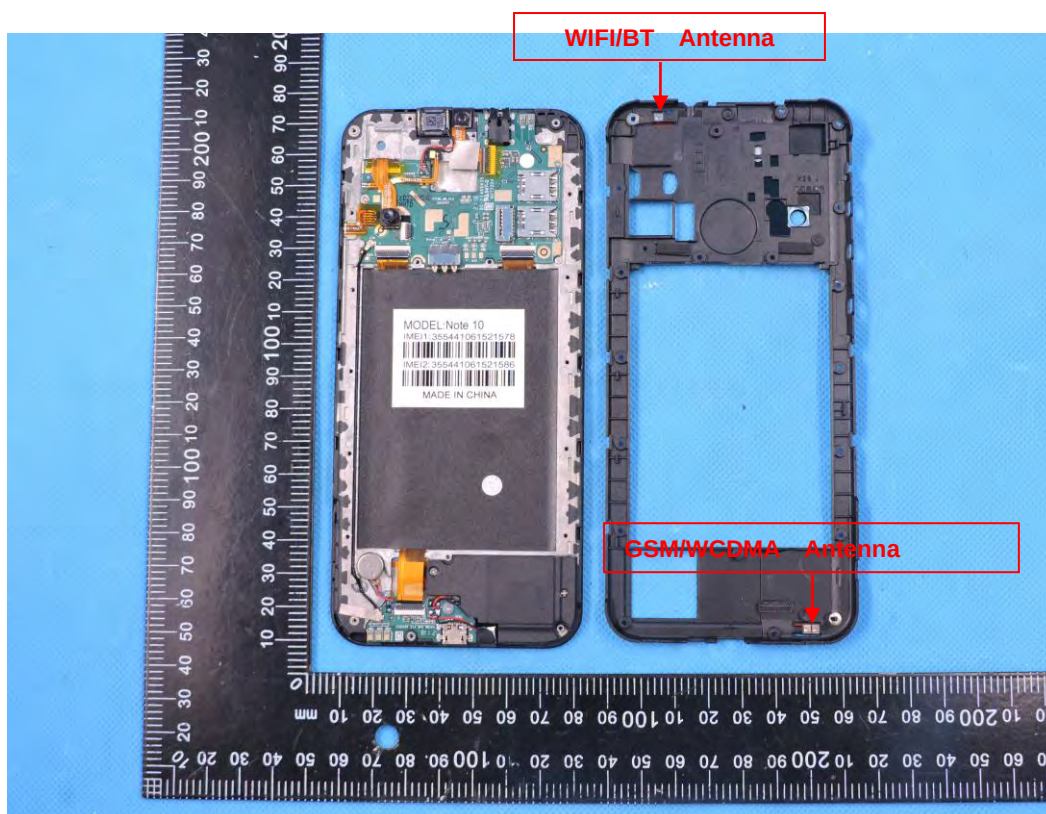


Photo 4

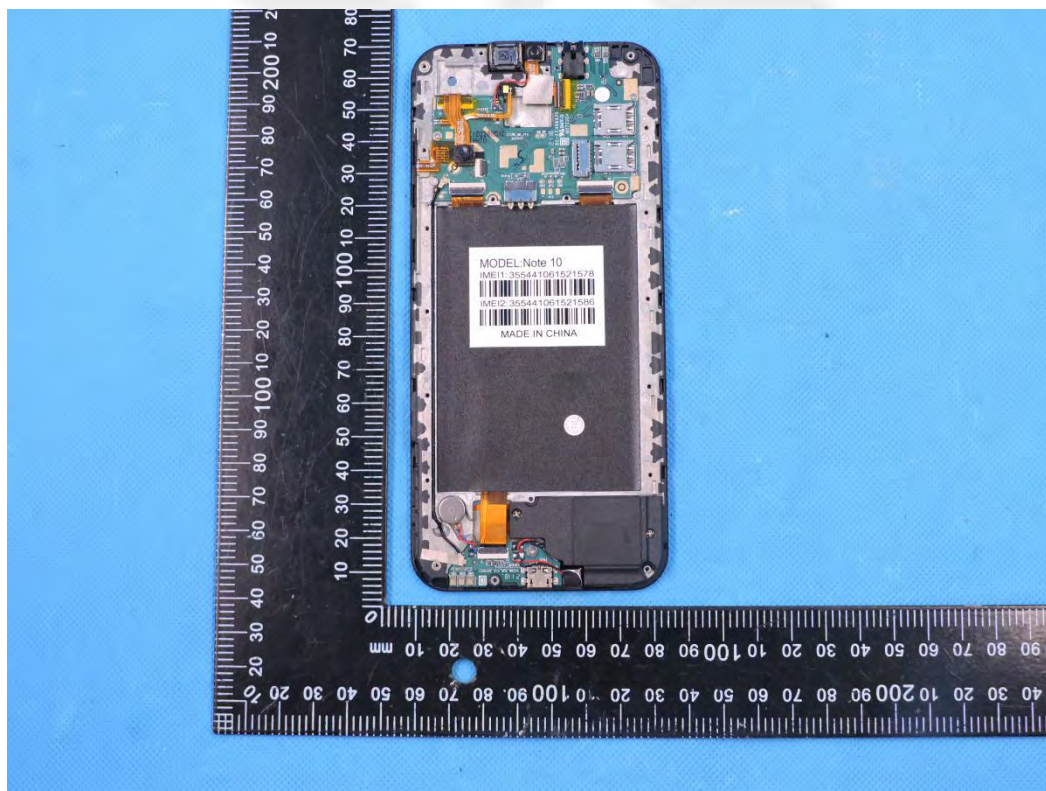


Photo 5

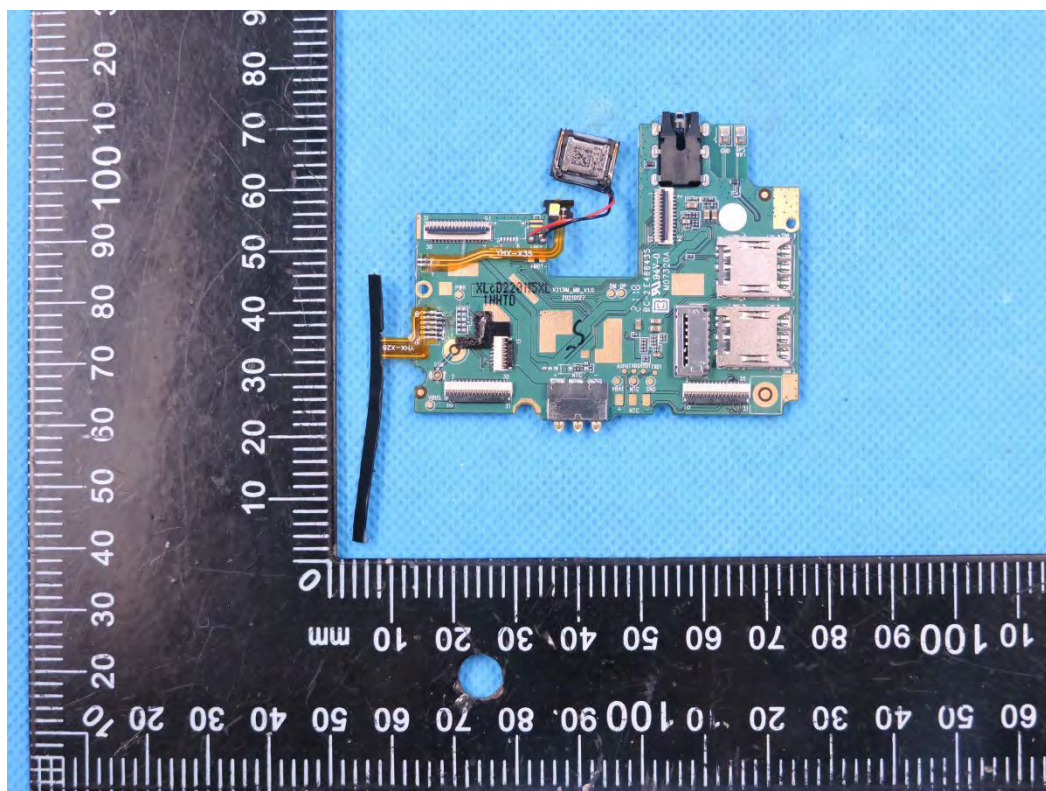
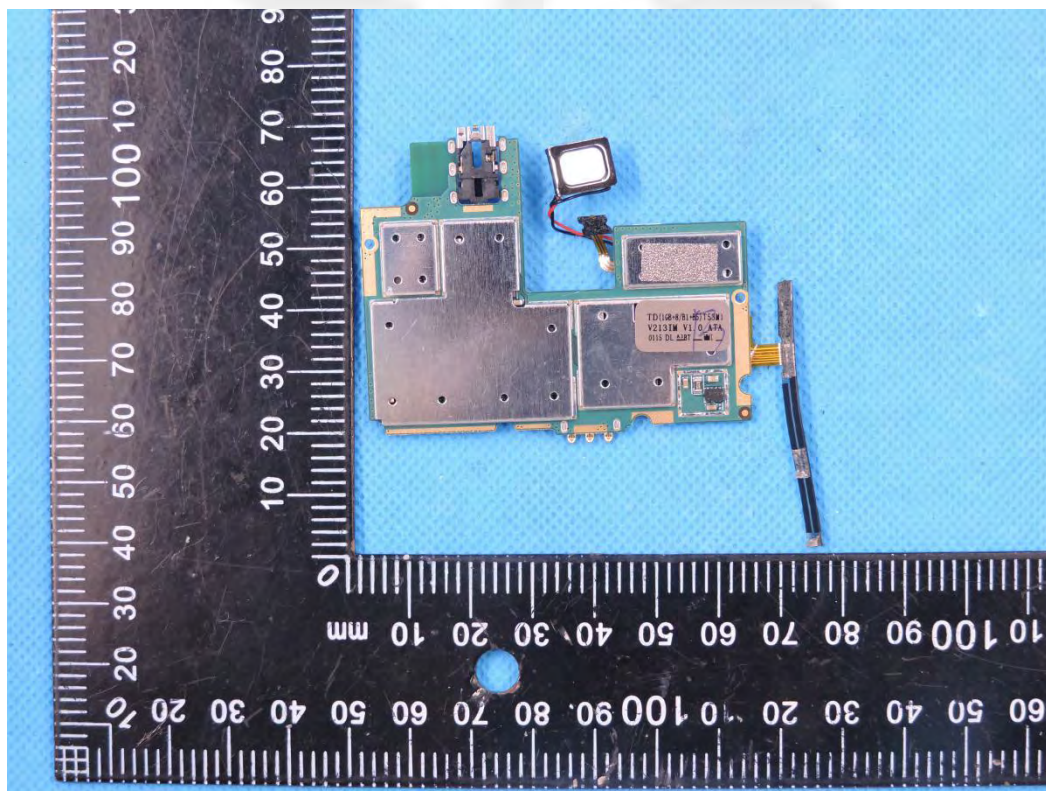


Photo 6





A photograph of a disassembled mobile phone. The main circuit board is shown, featuring various components such as the processor, memory, and camera module. The board is placed next to a ruler for scale. The ruler shows measurements in centimeters and millimeters. The phone's components are laid out on a light blue surface. The main board has a green PCB with gold-plated edges. A black battery is connected to the board via a red and black cable. A small black camera module is also visible. The phone's frame is partially visible on the right side.

The image shows a close-up of a green PCB with several key components:

- Main Processor:** MEDIATEK ARM MT6580A 1782-WAHHTA DTTBT571 ATG282XLD
- Left Chip:** SAMSUNG KMX1X000VM-B314 S27FR1D 416
- Top Left Chips:** MEDIATEK CC1A4MCKW and MEDIATEK MT6523GA 1444-ANJH
- Right Side Chips:** HS6684E MO13021 049NIGM and HS6359E 600110V 030UKAM
- Bottom Right Chip:** MTK MT6575T 1504AMJH BTP1TW64

A black battery pack is connected to the top of the board via red and black wires.

Photo 9

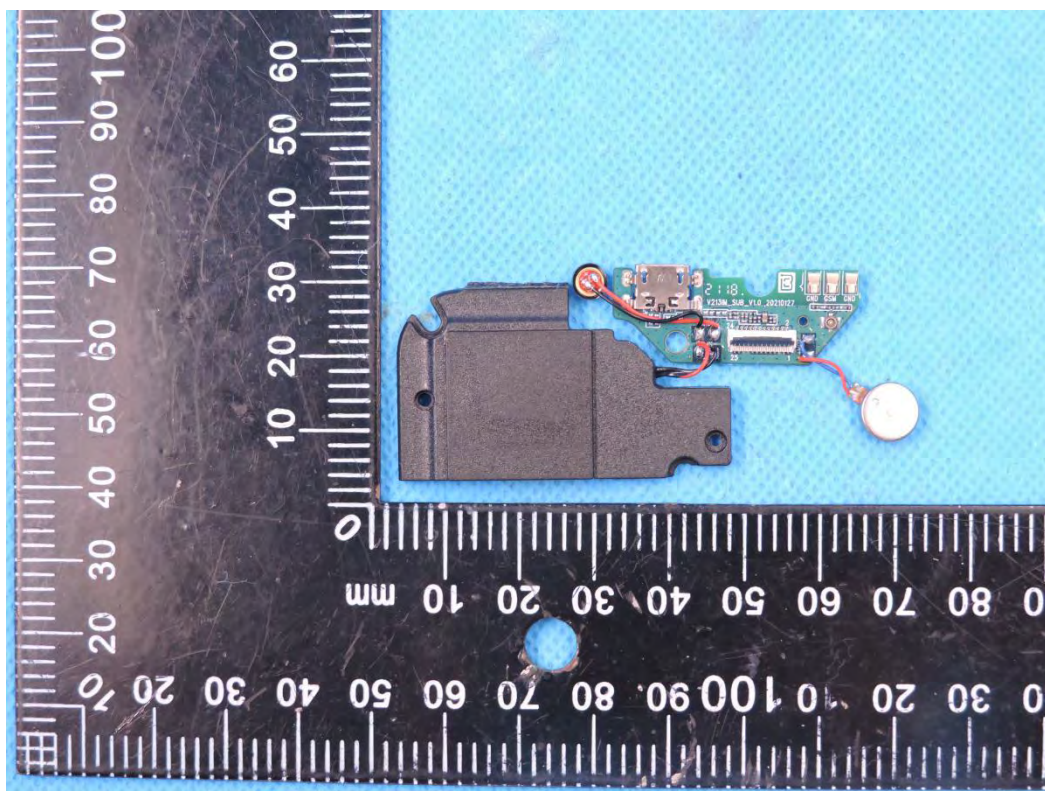


Photo 10

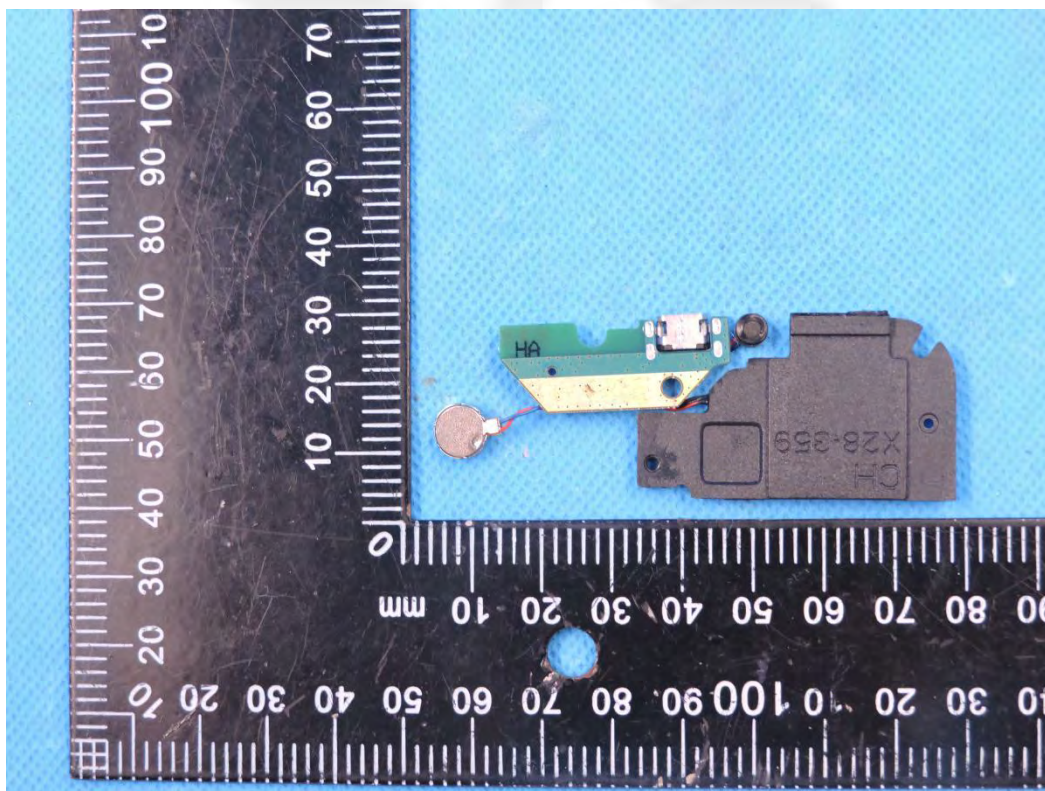


Photo 11

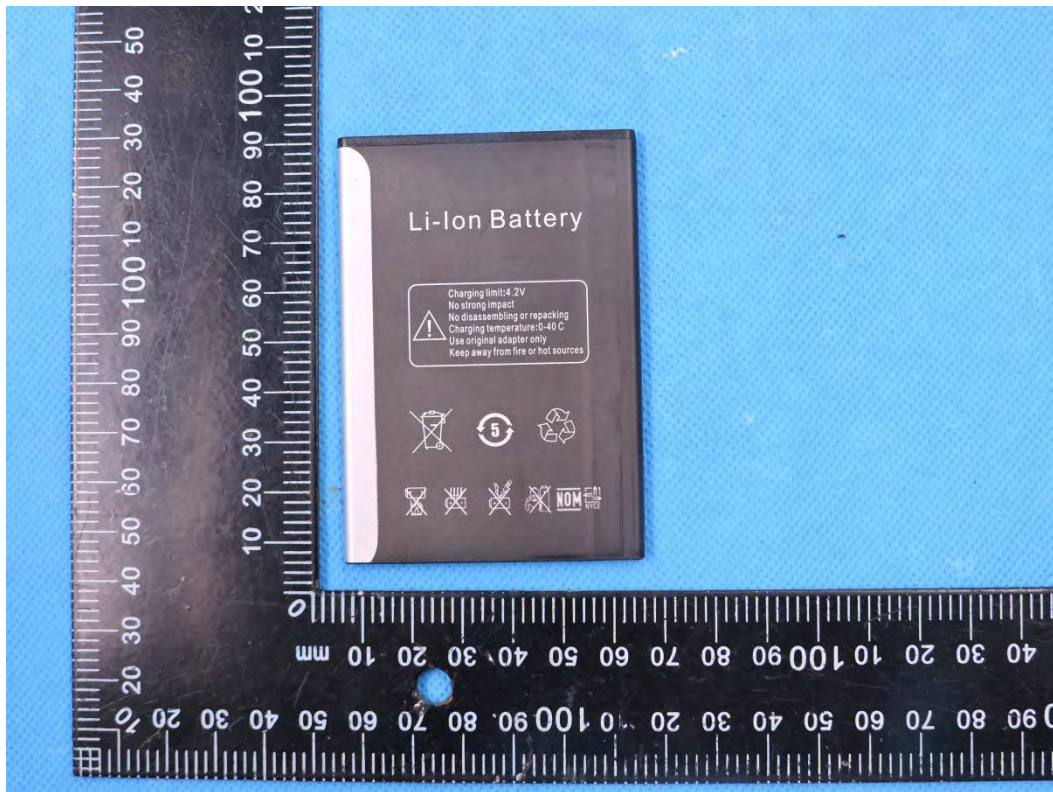


Photo 12

